



566.40595X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. TANEI, et al.
Serial No.: 09/941,988
Filed: August 30, 2001
For: ELECTRONIC COMPONENT AND METHOD
OF MANUFACTURING THE SAME
Group: 1775
Examiner: Gwendolyn A. Blackwell Rudasil

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TC 1700 MAIL ROOM
OCT 25 2002
[Handwritten signature]

AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

October 24, 2002

Sir:

In response to the Office Action mailed September 24, 2002, please amend
the above-identified application as follows:

IN THE CLAIMS:

Please amend the claims presently in the application as follows:

-
1. (Amended) An electronic component comprising:
a ceramic board containing glass; and
a conductor film stuck to the ceramic board,
wherein the conductor film is formed by firing a conductor paste, which does
not contain any glass and which contains a silver particle having a specific surface
area of $0.3 \text{ m}^2/\text{g}$ to $3.0 \text{ m}^2/\text{g}$, at a temperature having a difference of $\pm 50^\circ\text{C}$ from a
softening temperature of the glass, the conductor paste having been stuck on a
- [Handwritten signature]*